TC1173

300mA CMOS LDO with Shutdown ERROR Output and Bypass

Features

- · Extremely Low Supply Current for Longer Battery Life
- · Very Low Dropout Voltage
- · 300mA Output Current
- · Standard or Custom Output Voltages
- ERROR Output Can Be Used as a Low Battery Detector or Processor Reset Generator
- · Power Saving Shutdown Mode
- · Bypass Input for Ultra Quiet Operation
- · Over Current and Over Temperature Protection
- · Space-Saving MSOP Package Option

Applications

- · Battery Operated Systems
- · Portable Computers
- · Medical Instruments
- Instrumentation
- · Cellular/GSM/PHS Phones
- · Linear Post-Regulators for SMPS
- Pagers

Device Selection Table

Part Number	Package	Junction Temp. Range
TC1173-xxVOA	8-Pin SOIC	-40°C to +125°C
TC1173-xxVUA	8-Pin MSOP	-40°C to +125°C

NOTE: xx indicates output voltages

Available Output Voltages: 2.5, 2.8, 3.0, 3.3, 5.0.

Other output voltages are available. Please contact Microchip

Technology Inc. for details.

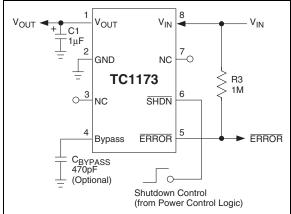
General Description

The TC1173 is a precision output (typically $\pm 0.5\%$) CMOS low dropout regulator. Total supply current is typically 50μ A at full load (20 to 60 times lower than in bipolar regulators).

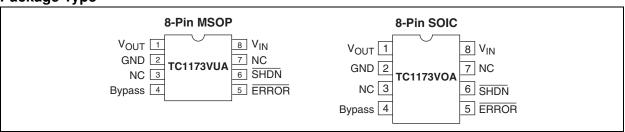
TC1173 key features include ultra low noise operation (plus optional Bypass input); very low dropout voltage (typically 240mV at full load) and internal feed-forward compensation for fast response to step changes in load. An error output (ERROR) is asserted when the TC1173 is out-of-regulation (due to a low input voltage or excessive output current). ERROR can be set as a low battery warning or as a processor RESET signal (with the addition of an external RC network). Supply current is reduced to $0.05\mu A$ (typical) and VouT and ERROR fall to zero when the shutdown input is low.

The TC1173 incorporates both over temperature and over current protection. The TC1173 is stable with an output capacitor of only $1\mu F$ and has a maximum output current of 300mA.

Typical Application



Package Type



1.0 **ELECTRICAL CHARACTERISTICS**

Absolute Maximum Ratings*

Input Voltage6.5V
Output Voltage $(V_{SS} - 0.3V)$ to $(V_{IN} + 0.3V)$
Power DissipationInternally Limited (Note 6)
Maximum Voltage on Any Pin $\dots V_{IN}$ +0.3V to -0.3V
Operating Temperature Range40°C < T_J < 125°C
Storage Temperature65°C to +150°C

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC1173 ELECTRICAL SPECIFICATIONS

Electrical Characteristics: $V_{IN} = V_{OUT} + 1V$, $I_L = 0.1$ mA, $C_L = 3.3$ µF, $\overline{SHDN} > V_{IH}$, $T_A = 25$ °C, unless otherwise noted. **Boldface**

type specificat	ions apply for junction temperatures	of -40°C to +	125°C.			
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions
V _{IN}	Input Operating Voltage	2.7	_	6.0	V	Note 8
I _{OUTMAX}	Maximum Output Current	300	_	_	mA	
V _{OUT}	Output Voltage	 V _R -2.5%	V _R ±0.5%	— V _R + 2.5%	>	Note 1
$\Delta V_{OUT}/\Delta T$	V _{OUT} Temperature Coefficient		40	_	ppm/°C	Note 2
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	_	0.05	0.35	%	$(V_R + 1V) \le V_{IN} \le 6V$
$\Delta V_{OUT}/V_{OUT}$	Load Regulation	_	0.5	2.0	%	$I_L = 0.1$ mA to I_{OUTMAX} (Note 3)
V _{IN} -V _{OUT}	Dropout Voltage	_ _ _	20 80 240	30 160 480	mV	I _L = 0.1mA I _L = 100mA I _L = 300mA (Note 4)
I _{SS1}	Supply Current	_	50	90	μΑ	SHDN = V _{IH} ,
I _{SS2}	Shutdown Supply Current	_	0.05	0.5	μΑ	SHDN = 0V
PSRR	Power Supply Rejection Ratio	_	60	_	dB	F _{RE} ≤ 1kHz
I _{OUTSC}	Output Short Circuit Current	_	550	650	mA	V _{OUT} = 0V
$\Delta V_{OUT}/\Delta P_{D}$	Thermal Regulation	_	0.04	_	V/W	Note 5
eN	Output Noise	_	260	_	nV/√ Hz	$F = 1kHz, C_{OUT} = 1\mu F, \\ R_{LOAD} = 50\Omega$
SHDN Input						
V_{IH}	SHDN Input High Threshold	45	_	_	%V _{IN}	
V_{IL}	SHDN Input Low Threshold	_	_	15	%V _{IN}	
ERROR Outp	ut					
V _{MIN}	Minimum Operating Voltage	1.0	_	_	٧	
V _{OL}	Output Logic Low Voltage	_		400	mV	1 mA Flows to ERROR
V_{TH}	ERROR Threshold Voltage	_	0.95 x V _R	_	٧	
V_{OL}	ERROR Positive Hysteresis	_	50		mV	Note 7

 1: V_R is the user-programmed regulator output voltage setting.
 2: TC V_{OUT} = (V_{OUTMAN} - V_{OUTMIN}) x 10⁶ Note

- V_{OUT} x ΔT
- Regulation is measured at a constant junction temperature using low duty cycle pulse testing. Load regulation is tested over a load range from 0.1mA to the maximum specified output current. Changes in output voltage due to heating effects are covered by the thermal regula-
- Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at a 1V differential.
- Thermal Regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a current pulse equal to I_{LMAX} at V_{IN} = 6V for T = 10 msec.
- The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction-to-air (i.e., T_A , T_J , θ_{JA}). Exceeding the maximum allowable power dissipation causes the device to initiate thermal shutdown. Please see Section 4.0 Thermal Considerations for more details.
- Hysteresis voltage is referenced by V_R . The minimum V_{IN} has to justify the conditions: $V_{IN} \ge V_R + V_{DROPOUT}$ and $V_{IN} \ge 2.7V$ for $I_L = 0.1 \text{mA}$ to $I_{OUT_{MAX}}$.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

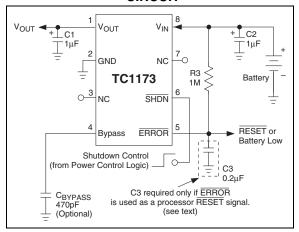
Pin No. (8-Pin SOIC) (8-Pin MSOP)	Symbol	Description
1	V_{OUT}	Regulated voltage output.
2	GND	Ground terminal.
3	NC	No connect.
4	Bypass	Reference bypass input. Connecting a 470pF to this input further reduces output noise.
5	ERROR	Out-of-Regulation Flag. (Open drain output). This output goes low when V_{OUT} is out-of-tolerance by approximately -5% .
6	SHDN	Shutdown control input. The regulator is fully enabled when a logic high is applied to this input. The regulator enters shutdown when a logic low is applied to this input. During shutdown, output voltage falls to zero and supply current is reduced to $0.05\mu A$ (typical).
7	NC	No connect.
8	V _{IN}	Unregulated supply input.

3.0 DETAILED DESCRIPTION

The TC1173 is a fixed output, low drop-out regulator. Unlike bipolar regulators, the TC1173's supply current does not increase with load current. In addition, V_{OUT} remains stable and within regulation over the entire 0mA to I_{OUTMAX} operating load current range, (an important consideration in RTC and CMOS RAM battery back-up applications).

Figure 3-1 shows a typical application circuit. The regulator is enabled any time the shutdown input (SHDN) is at or above V_{IH} , and shutdown (disabled) when SHDN is at or below V_{IL} . SHDN may be controlled by a CMOS logic gate, or I/O port of a microcontroller. If the SHDN input is not required, it should be connected directly to the input supply. While in shutdown, supply current decreases to $0.05\mu A$ (typical), V_{OUT} falls to zero and \overline{ERROR} is disabled.

FIGURE 3-1: TYPICAL APPLICATION CIRCUIT



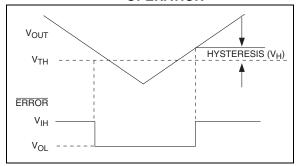
3.1 ERROR Output

 $\overline{\text{ERROR}}$ is driven low whenever V_{OUT} falls out of regulation by more than - 5% (typical). This condition may be caused by low input voltage, output current limiting, or thermal limiting. The $\overline{\text{ERROR}}$ threshold is 5% below rated V_{OUT} regardless of the programmed output voltage value (e.g., $\overline{\text{ERROR}} = V_{OL}$ at 4.75V (typ.) for a 5.0V regulator and 2.85V (typ.) for a 3.0V regulator). $\overline{\text{ERROR}}$ output operation is shown in Figure 3-2.

Note that ERROR is active when V_{OUT} is at or below V_{TH} , and inactive when V_{OUT} is above V_{TH} + V_{H} .

As shown in Figure 3-1, $\overline{\text{ERROR}}$ can be used as a battery low flag, or as a processor $\overline{\text{RESET}}$ signal (with the addition of timing capacitor C3). R1 x C3 should be chosen to maintain $\overline{\text{ERROR}}$ below V_{IH} of the processor $\overline{\text{RESET}}$ input for at least 200 msec to allow time for the system to stabilize. Pull-up resistor R1 can be tied to V_{OUT} , V_{IN} or any other voltage less than $(V_{IN} + 0.3V)$.

FIGURE 3-2: ERROR OUTPUT OPERATION



3.2 Output Capacitor

A $1\mu F$ (min) capacitor from V_{OUT} to ground is recommended. The output capacitor should have an effective series resistance greater than 0.1Ω and less than 5.0 Ω . A 1 μ F capacitor should be connected from V_{IN} to GND if there is more than 10 inches of wire between the regulator and the AC filter capacitor, or if a battery is used as the power source. Aluminum electrolytic or tantalum capacitor types can be used. (Since many aluminum electrolytic capacitors freeze at approximately -30°C, solid tantalums are recommended for applications operating below -25°C.) When operating from sources other than batteries, supply-noise rejection and transient response can be improved by increasing the value of the input and output capacitors and employing passive filtering techniques.

3.3 Bypass Input

A 470pF capacitor connected from the Bypass input to ground reduces noise present on the internal reference, which in turn significantly reduces output noise. If output noise is not a concern, this input may be left unconnected. Larger capacitor values may be used, but results in a longer time period to rated output voltage when power is initially applied.

4.0 THERMAL CONSIDERATIONS

4.1 Thermal Shutdown

Integrated thermal protection circuitry shuts the regulator off when die temperature exceeds 150°C. The regulator remains off until the die temperature drops to approximately 140°C.

4.2 Power Dissipation

The amount of power the regulator dissipates is primarily a function of input and output voltage, and output current. The following equation is used to calculate worst case actual power dissipation:

EQUATION 4-1:

$$P_D \approx (V_{INMAX} - V_{OUTMIN})I_{LOADMAX}$$

Where:

P_D = Worst case actual power dissipation

 V_{INMAX} = Maximum voltage on V_{IN}

V_{OUTMIN} = Minimum regulator output voltage

I_{LOADMAX} = Maximum output (load) current

The maximum allowable power dissipation (Equation 4-2) is a function of the maximum ambient temperature (T_{AMAX}), the maximum allowable die temperature (T_{JMAX}) and the thermal resistance from junction-to-air (θ_{JA}). The 8-Pin SOIC package has a θ_{JA} of approximately 160°C/Watt, while the 8-Pin MSOP package has a θ_{JA} of approximately 200°C/Watt.

EQUATION 4-2:

$$P_{DMAX} = \frac{(T_{JMAX} - T_{AMAX})}{\theta_{JA}}$$

Where all terms are previously defined.

Equation 4-1 can be used in conjunction with Equation 4-2 to ensure regulator thermal operation is within limits. For example:

Given:

 $V_{INMAX} = 3.0V \pm 10\%$

 $V_{OUTMIN} = 2.7V \pm 0.5\%$

 $I_{LOADMAX} = 250mA$

 $T_{\text{JMAX}} = 125^{\circ}\text{C}$ $T_{\text{AMAX}} = 55^{\circ}\text{C}$

 $\theta_{\text{JA}} = 200^{\circ}\text{C/W}$

8-Pin MSOP Package

Find: 1. Actual power dissipation

2. Maximum allowable dissipation

Actual power dissipation:

$$P_D \approx (V_{INMAX} - V_{OUTMIN})I_{LOADMAX}$$

$$= [(3.0 \times 1.1) - (2.7 \times .995)]250 \times 10^{-3}$$

= 155mW

Maximum allowable power dissipation:

$$P_{DMAX} = \frac{(T_{JMAX} - T_{AMAX})}{\theta_{JA}}$$
$$= \frac{(125 - 55)}{200}$$
$$= 350 \text{mW}$$

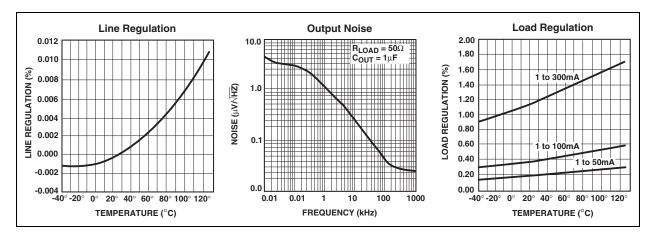
In this example, the TC1173 dissipates a maximum of 155mW; below the allowable limit of 350mW. In a similar manner, Equation 4-1 and Equation 4-2 can be used to calculate maximum current and/or input voltage limits. For example, the maximum allowable V_{IN} is found by substituting the maximum allowable power dissipation of 250mW into Equation 4-1, from which $V_{\text{INMAX}} = 4.1 \text{V}.$

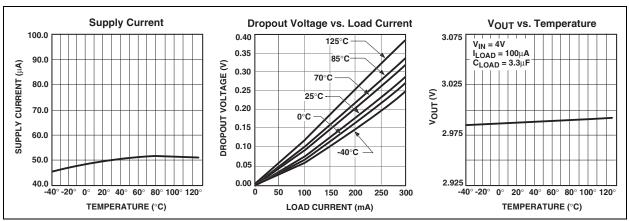
4.3 Layout Considerations

The primary path of heat conduction out of the package is via the package leads. Therefore, layouts having a ground plane, wide traces at the pads, and wide power supply bus lines combine to lower θ_{JA} and therefore increase the maximum allowable power dissipation limit.

5.0 TYPICAL CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



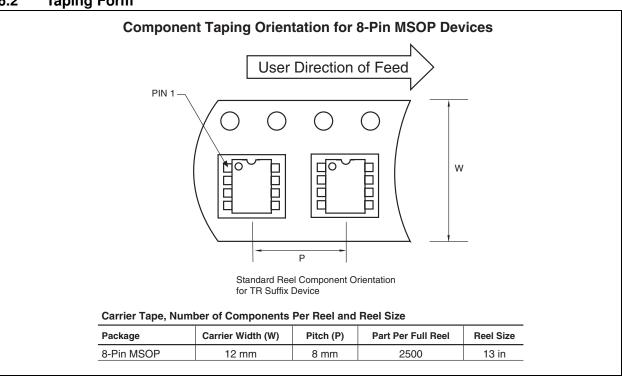


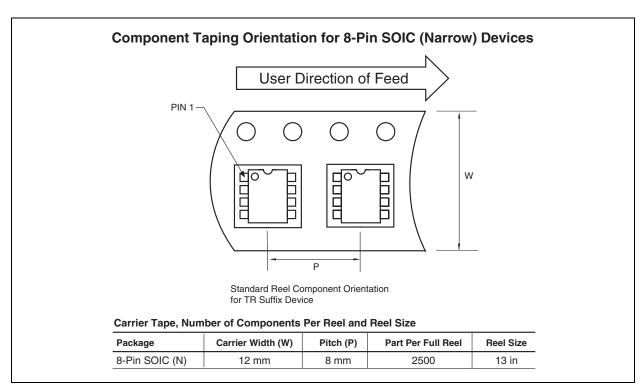
6.0 PACKAGING INFORMATION

6.1 **Package Marking Information**

Package marking data not available at this time.

6.2 **Taping Form**





6.3 Package Dimensions

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging 8-Pin MSOP PIN 1 .122 (3.10) .197 (5.00) .114 (2.90) .189 (4.80) .026 (0.65) TYP. .122 (3.10) .114 (2.90) .043 (1.10) .008 (0.20) MÀX. .005 (0.13) .016 (0.40) .006 (0.15) .028 (0.70) .010 (0.25) .016 (0.40) .002 (0.05) Dimensions: inches (mm)

For the most current package drawings, please see the Microchip Packaging Specification located Note: at http://www.microchip.com/packaging 8-Pin SOIC PIN 1 AA.157 (3.99) .244 (6.20) .150 (3.81) .228 (5.79) .050 (1.27) TYP. .197 (5.00) .189 (4.80) .069 (1.75) .053 (1.35) .010 (0.25) 8° MAX 7.007 (0.18) .020 (0.51) .010 (0.25) .050 (1.27) .016 (0.40) .013 (0.33) .004 (0.10) Dimensions: inches (mm)

TC1173

REVISION HISTORY

Revision C (November 2012)

Added a note to each package outline drawing.

SALES AND SUPPORT

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. Your local Microchip sales office
- 2. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System

Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

Т	\frown 1	1	72	
	U I		<i>1</i> 0	

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the
 intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
 knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
 Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. & KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2002-2012, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

ISBN: 9781620767375

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277

Technical Support: http://www.microchip.com/

support

Web Address: www.microchip.com

Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Cleveland

Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis Noblesville, IN

Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong

Tel: 852-2401-1200 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou Tel: 86-571-2819-3187 Fax: 86-571-2819-3189

China - Hong Kong SAR

Tel: 852-2401-1200 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8203-2660

Fax: 86-755-8203-1760 **China - Wuhan**

Tel: 86-27-5980-5300

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian

Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Xiamen Tel: 86-592-2388138

Fax: 86-592-2388130 China - Zhuhai

Tel: 86-756-3210040 Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi

Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Osaka

Tel: 81-66-152-7160 Fax: 81-66-152-9310

Japan - Yokohama

Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857 Fax: 60-3-6201-9859 Malaysia - Penang

Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila

Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu

Tel: 886-3-5778-366 Fax: 886-3-5770-955 Taiwan - Kaohsiung

Tel: 886-7-213-7828

Fax: 886-7-330-9305

Taiwan - Taipei

Tel: 886-2-2508-8600 Fax: 886-2-2508-0102 Thailand - Bangkok

Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 **Denmark - Copenhagen**

Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen

Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid

Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

UK - Wokingham Tel: 44-118-921-5869 Fax: 44-118-921-5820

10/26/12